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- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- True Data Paths
- High-Current 3-State Outputs Can Drive up to 15 LSTTL Loads
- Package Options Include Plastic Small-Outline (DW) and Ceramic Flat (W)
 Packages, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT)
 300-mil DIPs

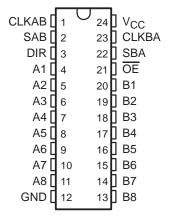
description

The 'HC646 consist of bus-transceiver circuits with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental busmanagement functions that can be performed with the 'HC646.

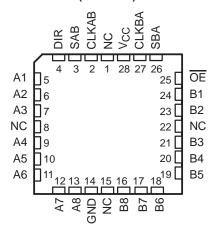
Output-enable (OE) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either or both registers.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when \overline{OE} is active (low). In the isolation mode (\overline{OE} high), A data may be stored in one register and/or B data may be stored in the other register.

SN54HC646...JT OR W PACKAGE SN74HC646...DW OR NT PACKAGE (TOP VIEW)



SN54HC646 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

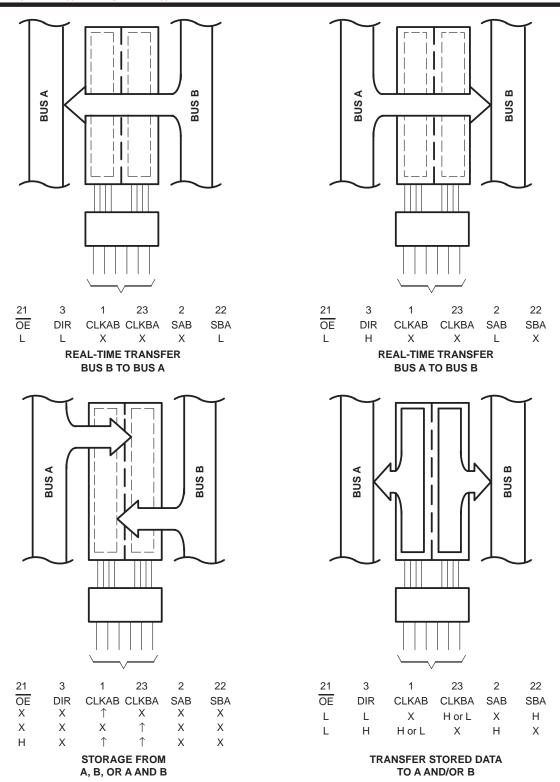
When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The SN54HC646 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74HC646 is characterized for operation from -40° C to 85° C.



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Pin numbers shown are for the DW, JT, NT, and W packages.

Figure 1. Bus-Management Functions



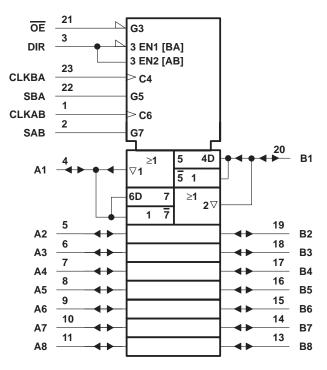
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FUNCTION TABLE

			UTS			DAT	A I/O	OPERATION OR FUNCTION
OE	DIR	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	OPERATION OR FUNCTION
Х	Х	1	Х	Х	Х	Input	Unspecified [†]	Store A, B unspecified [†]
Х	Х	Χ	1	Χ	Χ	Unspecified [†]	Input	Store B, A unspecified [†]
Н	Х	1	↑	Х	Χ	Input	Input	Store A and B data
Н	Χ	H or L	H or L	Χ	Χ	Input disabled	Input disabled	Isolation, hold storage
L	L	Х	Х	Х	L	Output	Input	Real-time B data to A bus
L	L	Χ	H or L	Χ	Н	Output	Input	Stored B data to A bus
L	Н	Х	Х	Ĺ	Х	Input	Output	Real-time A data to B bus
L	Н	H or L	Х	Н	Х	Input	Output	Stored A data to B bus

[†] The data-output functions can be enabled or disabled by various signals at $\overline{\text{OE}}$ and DIR. Data-input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

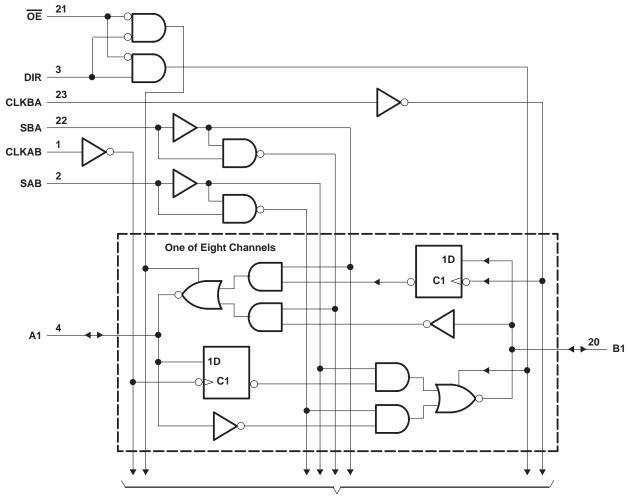
logic symbol‡



 $[\]ddagger$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DW, JT, NT, and W packages.

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logic diagram (positive logic)



To Seven Other Channels

Pin numbers shown are for the DW, JT, NT, and W packages.

absolute maximum ratings over operating free-air temperature range†

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input clamp current, $I_{ K }(V_1 < 0 \text{ or } V_1 > V_{CC})$ (see Note 1)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±35 mA
Continuous current through V _{CC} or GND	±70 mA
Package thermal impedance, θ _{JA} (see Note 2): DW package	81°C/W
NT package	67°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

^{2.} The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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recommended operating conditions

			SN	SN54HC646		SN	174HC64	16	LINUT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		2	5	6	2	5	6	V
		V _{CC} = 2 V	1.5			1.5			
V_{IH}	High-level input voltage	V _{CC} = 4.5 V	3.15			3.15			V
		V _{CC} = 6 V	4.2		7	4.2			
		V _{CC} = 2 V	0	Ş	0.5	0		0.5	
V_{IL}	Low-level input voltage	V _{CC} = 4.5 V	0	Q.	1.35	0		1.35	V
		V _{CC} = 6 V	0	5	1.8	0		1.8	
VI	Input voltage		0,	5	VCC	0		VCC	V
٧o	Output voltage		0) The state of the	VCC	0		VCC	V
		V _{CC} = 2 V	90		1000	0		1000	
t _t	Input transition (rise and fall) time	V _{CC} = 4.5 V	0		500	0		500	ns
		V _{CC} = 6 V	0		400	0		400	
TA	Operating free-air temperature		-55		125	-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DAD	AMETER	TEST CONDITIONS		Vaa	Т	A = 25°C	;	SN54F	IC646	SN74HC646		UNIT
PARA	AIVIETER	1251 CC	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	ONII	
				2 V	1.9	1.998		1.9		1.9		
			I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4		
Vон		$V_I = V_{IH}$ or V_{IL}		6 V	5.9	5.999		5.9		5.9		V
			$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7	7	3.84		
			$I_{OH} = -7.8 \text{ mA}$	6 V	5.48	5.8		5.2	1/5	5.34		
				2 V		0.002	0.1		0.1		0.1	
		VI = VIH or VIL	I _{OL} = 20 μA	4.5 V		0.001	0.1	4	0.1		0.1	
VOL				6 V		0.001	0.1	5	0.1		0.1	V
			$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26	90	0.4		0.33	
			$I_{OL} = 7.8 \text{ mA}$	6 V		0.15	0.26	40	0.4		0.33	
II	Control inputs	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
loz	A or B	VO = VCC or 0		6 V		±0.01	±0.5		±10		±5	μΑ
ICC		$V_I = V_{CC}$ or 0,	IO = 0	6 V			8		160		80	μΑ
Ci	Control inputs			2 V to 6 V		3	10		10		10	pF

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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V	T _A =	25°C	SN54H	IC646	SN74F	IC646	UNIT
		VCC	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
		2 V	0	6	0	4.3	0	5.5	
fclock	Clock frequency	4.5 V	0	31	0	22	0	27	MHz
		6 V	0	36	0	25	0	31	
		2 V	80		115	151	95		
t _W	Pulse duration, CLKBA or CLKAB high or low	4.5 V	16		23	KEL	19		ns
			14		20	2	16		
		2 V	100		150		125		
t _{su}	Setup time, A before CLKAB↑ or B before CLKBA↑	4.5 V	20		30		25		ns
		6 V	17		26		21		
			5		5		5		
th	Hold time, A after CLKAB↑ or B after CLKBA↑	4.5 V	5		5		5		ns
			5		5		5		

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switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 2)

DADAMETED	FROM	то	V	T,	_A = 25°C	;	SN54F	IC646	SN74F	IC646	UNIT
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
			2 V	6	11		4.4		5.5		
f _{max}			4.5 V	31	54		22		27		MHz
			6 V	36	64		25		31		
			2 V		65	180		270		225	
	CLKBA or CLKAB	A or B	4.5 V		18	36		54		45	
			6 V		14	31		46		38	
			2 V		50	135		205		170	
t _{pd}	A or B	B or A	4.5 V		14	27		41		34	ns
			6 V		11	23		35		29	
			2 V		70	190		285		240	
	SBA or SAB†	A or B	4.5 V		20	38		57		48	
			6 V		16	32		48		41	
			2 V		85	245		370		305	
t _{en}	ŌĒ	A or B	4.5 V		25	49	0)2	74		61	ns
			6 V		20	42	70	63		52	
			2 V		85	245	9	370		305	
t _{dis}	ŌĒ	A or B	4.5 V		25	49		74		61	ns
			6 V		20	42		63		52	
			2 V		80	245		370		305	
t _{en}	DIR	A or B	4.5 V		25	49		74		61	ns
			6 V		20	42		63		52	
			2 V		80	245		370		305	
^t dis	DIR	A or B	4.5 V		25	49		74		61	ns
			6 V		20	42		63		52	
			2 V		28	60		90		75	
t _t		Any	4.5 V		8	12		18		15	ns
			6 V		6	10		15		13	

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

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switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 2)

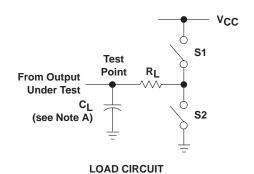
DADAMETED	FROM	то	V	T,	λ = 25°C	;	SN54l	HC646	SN74H	C646	LINUT
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
			2 V		90	265		400		330	
	CLKBA or CLKAB	A or B	4.5 V		24	53		80		66	
			6 V		20	46		68		57	
			2 V		70	220		335		280	
t _{pd}	A or B	B or A	4.5 V		20	44		67		56	ns
			6 V		15	38		57		49	
			2 V		80	275		415		345	
	SBA or SAB†	A or B	4.5 V		24	55	4	83		69	
			6 V		20	47	Č,	70		60	
		A or B	2 V		113	330	70	500		410	
	ŌĒ		4.5 V		33	66	⁷ Po	100		82	
			6 V		27	57	/	85		71	
^t en			2 V		113	330		500		410	ns
	DIR	A or B	4.5 V		33	66		100		82	
			6 V		27	57		85		71	
			2 V		45	210		315		265	
t _t		Any	4.5 V		17	42		63		53	ns
					13	36		53		43	

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

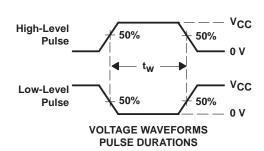
operating characteristics, $T_A = 25^{\circ}C$

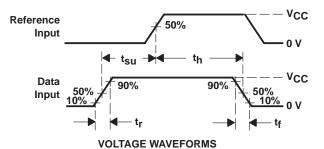
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	50	pF

PARAMETER MEASUREMENT INFORMATION



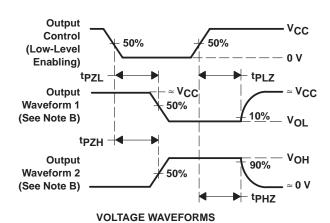
PARAI	PARAMETER		RL CL		S2	
	t _{PZH} 50 pF		Open	Closed		
ten t	tPZL	- 1 kΩ or 150 pF		Closed	Open	
tdis	tPHZ	1 kΩ	50 pF	Open	Closed	
dis	tPLZ	1 132	30 pi	Closed	Open	
t _{pd} or	t _{pd} or t _t		50 pF or 150 pF	Open	Open	





SETUP AND HOLD AND INPUT RISE AND FALL TIMES

VCC Input 50% 50% 0 V - tPLH ^tPHL ۷он In-Phase 90% 90% 50% Output 10% VOL 10 **tPHL** ^tPLH 90% 90% Out-of-50% 10% Phase VOL Output **VOLTAGE WAVEFORMS**



ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C_L includes probe and test-fixture capacitance.

PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r = 6 \text{ ns}$, $t_f = 6 \text{ ns}$.
- D. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. tpLz and tpHz are the same as t_{dis}.
- G. tpzL and tpzH are the same as ten.
- H. tpLH and tpHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms



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